

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static						<u> </u>	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V, } I_D = 250 \mu\text{A}$	30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L 050A		30		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		6			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1		3	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	°C 10		1	μΑ	
		V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α	
		V _{GS} = 10 V, I _D = 10 A		0.007	0.0090		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 8 A		0.0095	0.012	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 10 A		45		S	
Dynamic ^b		-				1	
Input Capacitance	C _{iss}			1525		pF	
Output Capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		295			
Reverse Transfer Capacitance	C _{rss}	30 00		120			
		V _{DS} = 15 V, V _{GS} = 10 V, I _D = 12 A		23.5	35	nC	
Total Gate Charge	Q_g			10.5	17		
Gate-Source Charge	Q _{gs}			4.3			
Gate-Drain Charge	Q _{gd}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 12 \text{ A}$		3			
Gate Resistance	R _g	f = 1 MHz		1.4	2.2	Ω	
Turn-on Delay Time	t _{d(on)}			18	30	ns	
Rise Time	t _r	V 45V D 450		160	240		
Turn-Off Delay Time	t _{d(off)}	$V_{DD} = 15 \text{ V}, R_{L} = 1.5 \Omega$ $I_{D} \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_{q} = 1 \Omega$		18	30		
Fall Time	t _f	$I_D = 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, H_g = 1.52$		8	15		
Turn-on Delay Time	t _{d(on)}			8	15		
Rise Time	t _r	V 45V D 450		11	18		
Turn-Off Delay Time	t _{d(off)}	$V_{DD} = 15 \text{ V}, R_L = 1.5 \Omega$		22	35		
Fall Time	t _f	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		8	15		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	Is	T _C = 25 °C			4	А	
Pulse Diode Forward Current ^a	I _{SM}				50		
Body Diode Voltage	V _{SD}	I _S = 2.3 A		0.75	1.1	V	
Body Diode Reverse Recovery Time	t _{rr}			25	40	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			15	25	nC	
Reverse Recovery Fall Time	t _a	$I_F = 9.5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		13		ns	
Reverse Recovery Rise Time	t _b			12			

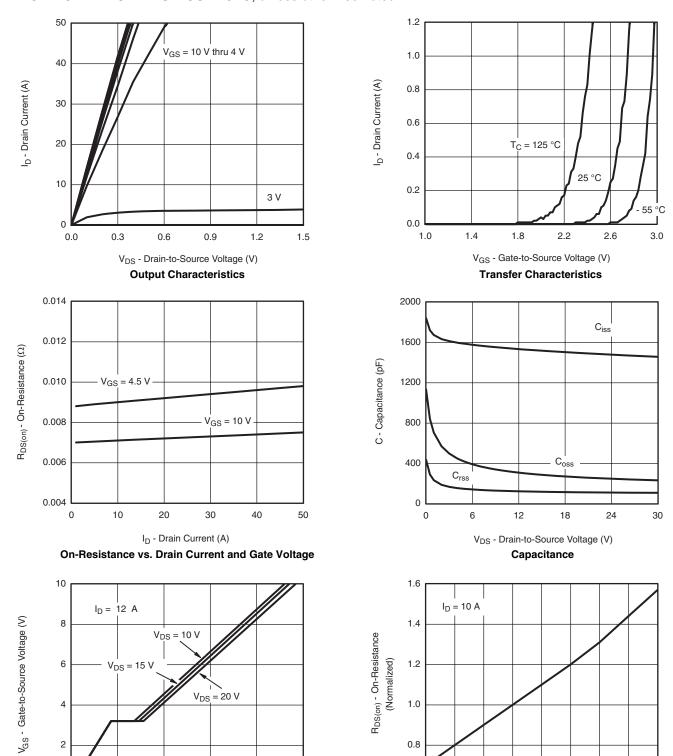
Notes:

- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



0.6

- 50

0

50

T_J - Junction Temperature (°C)

On-Resistance vs. Junction Temperature

75

100

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0

10

15

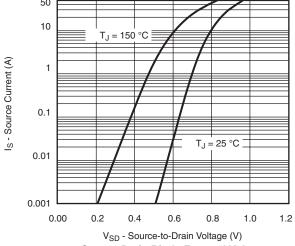
Q_q - Total Gate Charge (nC)

Gate Charge

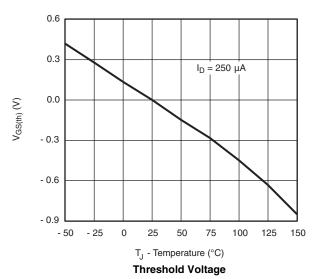
25

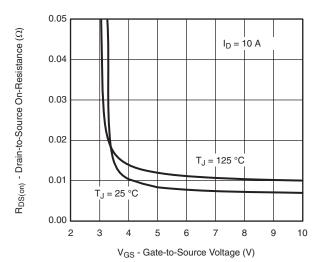
125

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

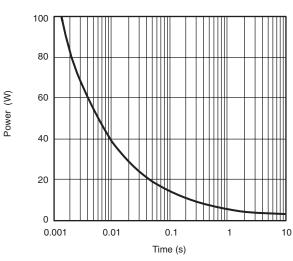


Source-Drain Diode Forward Voltage

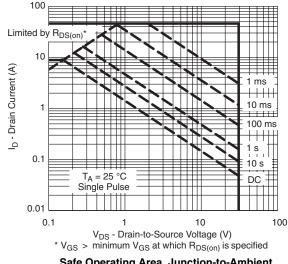




On-Resistance vs. Gate-to-Source Voltage



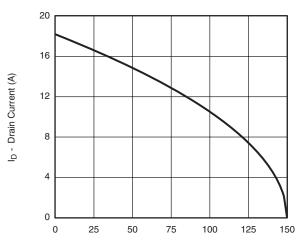
Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

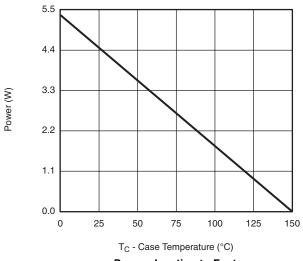


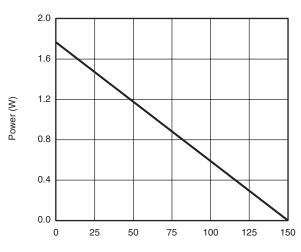
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



T_C - Case Temperature (°C)

Current Derating*





T_A - Ambient Temperature (°C)

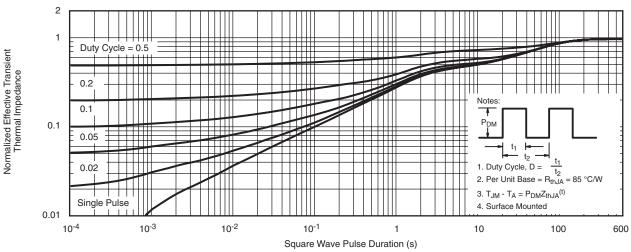
Power, Junction-to-Foot

Power, Junction-to-Ambient

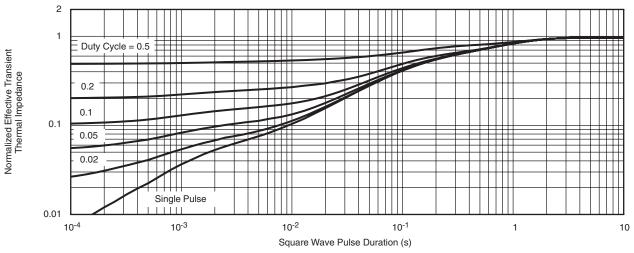
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



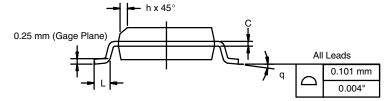
Normalized Thermal Transient Impedance, Junction-to-Case

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES					
DIM	Min	Max	Min	Max				
Α	1.35	1.75	0.053	0.069				
A ₁	0.10	0.20	0.004	0.008				
В	0.35	0.51	0.014	0.020				
С	0.19	0.25	0.0075	0.010				
D	4.80	5.00	0.189	0.196				
Е	3.80	4.00	0.150	0.157				
е	1.27	BSC	0.050 BSC					
Н	5.80	6.20	0.228	0.244				
h	0.25	0.50	0.010	0.020				
L	0.50	0.93	0.020	0.037				
q	0°	8°	0°	8°				
S	0.44	0.64	0.018	0.026				
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DWG: 5498

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RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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